

Features:

- Isolated mounting base 2500V~
- Simple design, Module and SCR rectifier bridge, Small volume, light weight

Typical Applications:

- Supplies for DC power equipment
- Field supply for DC motors
- Inverter welder

V _{DSM} ,V _{RSM}	V _{DRM} ,V _{RRM}	Type
900V	800V	MG200TH80S
1100V	1000V	MG200TH100S
1300V	1200V	MG200TH120S
1500V	1400V	MG200TH140S
1700V	1600V	MG200TH160S
1900V	1800V	MG200TH180S

Diode

SYMBOL	CHARACTERISTIC	TEST CONDITIONS	T _j (°C)	VALUE			UNIT
				Min	Type	Max	
I _D	DC output current	Three-phase full wave rectifying circuit, T _C =100°C	125			200	A
V _{RRM}	Repetitive peak reverse voltage	tp=10ms	125	600		1800	V
I _{RRM}	Repetitive peak current	at V _{RRM}	125			8	mA
I _{FSM}	Surge forward current	10ms half sine wave	125			1.5	kA
I ² t	I ² t for fusing coordination	V _R =0				11.25	A ² s*10 ³
V _{FO}	Threshold voltage		125			0.85	V
r _F	Forward slope resistance					1.2	mΩ
V _{FM}	Peak forward voltage	I _{FM} =200A	25			1.50	V
R _{th(j-c)}	Thermal resistance Junction to case	Single side cooled, per chip				0.10	°C /W
R _{th(c-h)}	Thermal resistance case to heatsink	Single side cooled, per chip				0.07	°C /W
V _{iso}	Isolation voltage	50Hz,R.M.S,t=1min,I _{iso} :1mA(max)		2500			V
F _m	Terminal connection torque(M6)				6		N·m
	Mounting torque(M6)				6		N·m
T _{stg}	Stored temperature			-40		125	°C
W _t	Weight				280		g
Outline	M33						

Thyristor

SYMBOL	CHARACTERISTIC	TEST CONDITIONS	T _j (°C)	VALUE			UNIT
				Min	Type	Max	
I _{T(AV)}	Mean on-state current	180° half sine wave 50Hz Single side cooled, T _c =100°C	125			200	A
V _{DRM} V _{RRM}	Repetitive peak off-state voltage Repetitive peak reverse voltage	tp=10ms	125	600		1800	V
I _{DRM} I _{RRM}	Repetitive peak current	at V _{DRM} at V _{RRM}	125			40	mA
I _{TSM}	Surge on-state current	10ms half sine wave	125			1.5	kA
I ² t	I ² t for fusing coordination	V _R =60%V _{RRM}				11.25	A ² s*10 ³
V _{TO}	Threshold voltage		125			0.85	V
r _T	On-state slope resistance					1.2	mΩ
I _{GT}	Gate trigger current		25	30		200	mA
V _{GT}	Gate trigger voltage	V _A =12V, I _A =1A		0.6		2.5	V
I _H	Holding current			10		250	mA
V _{TM}	Peak on-state voltage	I _{TM} =600A				1.75	V
dv/dt	Critical rate of rise of off-state voltage	V _{DM} =67%V _{DRM}	125			500	V/μs
R _{th(j-c)}	Thermal resistance Junction to case	Single side cooled, per chip				0.12	°C/W
R _{th(c-h)}	Thermal resistance case to heatsink	Single side cooled, per chip				0.10	°C/W
V _{iso}	Isolation voltage	50Hz, R.M.S, t=1min, I _{iso} : 1mA(MAX)		2500			V
F _m	Terminal connection torque(M6)				6		N·m
	Terminal connection torque(M4)				2.5		N·m
	Mounting torque(M6)				6		N·m
T _{stg}	Stored temperature			-40		125	°C
W _t	Weight				280		g
Outline	M33						

Outline:

